

# Edge Platform Wiwynn ES200

The Tailored-made MEC Server with Flexible Configurations for Various Edge Applications

#### **Short Chassis for Edge Deployment**

The ES200 is designed to be a stand-alone 2U MEC server with short depth of 450mm, which supports EIA-19" rack mount and especially for Telco 19" short rack. It is purposed to be a drop-in replacement under Telco environment that are not be modern as many recently built centralized data centers that comes with standard facilities.

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#### **NEBS-3 Compliant for Harsh Conditions**

ES200 is compliant to NEBS-3, which is a clear index that the hardware can endure varying and tough physical conditions. NEBS-3 comprises a number of guidelines for designing equipment that can be deployed where the operating conditions often are challenging. By compliant to NEBS-3, it is proved that ES200 is solid as a rock for edge environment.

### Hot-swappable PSU & FAN and Front I/O for Easy Services

ES200 comes with all front-end PCIe & storage I/O design which could expedite the services time at edge sites with limited space condition. At the rear, the system is equipped with 3+1 fan and 1+1 power redundancy to withstand single point of failure.

### New Intel Xeon Scalable Processors with Built-in Al Acceleration

ES200 is one of Edge Computing platform series, which supports two Intel 3rd Gen Intel® Xeon® Scalable Processors (codename Ice Lake), with 80 cores, that provides 40% performance improvement. With built-in Intel Deep Learning Boost, ES200 is ideal for complex AI workloads. ES200 also supports Intel Software Guard Extension (SGX), which helps secure data and application code, and Intel Speed Select, which helps optimize specific workload such as NFVI.

## Flexible Configuration for Various Edge Computing including Al Workloads

ES200 supports PCIe Gen4 which enables faster I/O speed for various edge applications. With flexible configurations of up to three PCIe Gen4 cards & two OCP NIC 3.0 cards, it is best suited for various AI workloads. With various storage modular design of different SKUs such as EDSFF, U.2 SSD the flexibility of system storage is ideal for different applications.

Wiwynn is a fast-growing cloud infrastructure provider that develops high-density computing and storage products, plus rack solutions for leading data centers.



	ES200-U	ES200-R
Form Factor	2U	
Processor	3rd Generation Intel® Xeon® Scalable Processors, TDP 250W/270W	
	Two	
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Memory	16 DIMM slots; DDR4 up to 3200 MT/s, and up to 64GB per DIMM;	
	12 DIININI SIOTS WITH UP TO 2 DCPMINIS (INTEL BARIOW PASS)	
Storage		
		• Eight EDSFF E1.S (5.9/9.5mm)
Expansion Slots	• Two PCle x16 FHFL Dual-width + One PCle x8 FHHL • One PCle x16 FHHL + Two PCle x8 FHHL	
Management I AN	·	
I/O Ports	<ul> <li>Power Button w/LED</li> <li>UID Button w/LED</li> <li>RST Button</li> <li>Three USB ports</li> <li>BMC Management port (front side)</li> <li>VGA port (D-sub)</li> </ul>	
Physical Specifications		
Dimensions	2U Rack; 86(H) * 440 (W) * 450 (D) (mm)	
Power Supply	Hot-pluggable, Redundant (1+1) 1600W CRPS	
Fan	Four 8038 dual rotor, Redundant (7+1)	
Weight	14.47kg	
Environment		
	<ul> <li>Ambient operating temperature range: -5 to +55 degree Celsius</li> <li>Operating and Storage relative humidity: 10% to 90% (non-condensing)</li> <li>Storage temperature range: -40 to +70 degree Celsius</li> </ul>	
	Processor Sockets Chipsets Security System Bus Memory  Storage  Expansion Slots  Management LAN I/O Ports  Physical Specifications Dimensions Power Supply Fan Weight	Form Factor  Processor  3rd Generation Intel® Xeon® Scalable Processor Sockets  Two Chipsets  Security  TPM v2.0 (option) System Bus  Intel® UltraPath Interconnect; 11.2GT/s  Memory  16 DIMM slots; DDR4 up to 3200 MT/s, an 12 DIMM slots with up to 2 DCPMMs (Intel® UltraPath up to 3200 MT/s, an 12 DIMM slots with up to 2 DCPMMs (Intel® UltraPath up to 3200 MT/s, an 12 DIMM slots with up to 2 DCPMMs (Intel® UltraPath up to 3200 MT/s, an 12 DIMM slots with up to 2 DCPMMs (Intel® UltraPath up to 3200 MT/s, an 12 DIMM slots with up to 2 DCPMMs (Intel® UltraPath up to 3200 MT/s, an 12 DIMM slots with up to 2 DCPMMs (Intel® UltraPath up to 3200 MT/s, an 12 DIMM slots with up to 2 DCPMMs (Intel® UltraPath up to 3200 MT/s, an 12 DIMM slots with up to 2 DCPMMs (Intel® UltraPath up to 3200 MT/s, an 12 DIMM slots with up to 3200 MT/s an 12 DIMM slots with up to 3200 MT/s an 12 DIMM slots with up to 3200 MT/s an 12 DIMM slots with up to 3200 MT/s an 12 DIMM slots with up to 3200 MT/s an 12 DIMM slots with up to 3200 MT/s an 12 DI



